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## PATENT ABSTRACTS OF JAPAN

(11)Publication number:

54-074591

(43)Date of publication of application: 14.06.1979

(51)Int.CI.

B23F 5/22

B23F 23/00

(21)Application number: 52-142412

(71)Applicant: MITSUBISHI HEAVY IND LTD

(22)Date of filing:

28.11.1977

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## (54) A DEVICE TO ADJUST THE DISTANCE BETWEEN CUTTER AND WORK

(57) Abstract:

PURPOSE: To perform high-precision adjustment by automatizing the measurement of overpin dimensions.

CONSTITUTION: A main control device provided with a signal processing arithmetic unit, a printing device, display device and an auxiliary control device is placed between measuring probe 1 and a drive unit. By this, electrical signal which shows the amount of displacement of measuring probe 10 advancing into groove 11 of the gear, an amount of displacement which has been formed on work 1 in accordance with the signal sent from the main control device, is fed to the signal processing arithemtic unit, and thereby the overpin dimensions which determine the thickness of gear formed on the work are automatically calculated, and the results are sent to the printing device, the display device and the auxiliary control device. Further, the drive unit, which adjusts the distance between hob 5 and work 1, operates on the basis of the difference between the overpin dimensions calculated by the auxiliary control device and the theoretical overpin dimensions. Consequently, personal errors due to human operation are eliminated.

## **LEGAL STATUS**

[Date of request for examination]

[Date of sending the examiner's decision of rejection]

[Kind of final disposal of application other than the examiner's decision of rejection or application converted registration]

[Date of final disposal for application]

[Patent number]

[Date of registration]

[Number of appeal against examiner's decision of rejection]

[Date of requesting appeal against examiner's decision of rejection]

[Date of extinction of right]

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